

Bluetooth Single-Chip Transceiver IC

Description

The T2901 is a bipolar integrated circuit manufactured using TEMIC Semiconductors' advanced UHF process.

This IC includes a transceiver for the 2.45 GHz ISM band especially for Bluetooth applications.

Features

- Complete Bluetooth transceiver with fully integrated synthesizer and VCO
- TX with advanced closed-loop modulation
- TX PA with +3 dBm output power at 2.5 GHz and ramp-signal generator for optional front end
- Image rejection mixer
- Auxiliary voltage regulator on chip
- Supply-voltage range 2.7 V to 3.3 V (6 V with additional external PNP transistor)
- Few low-cost external components / No mechanical tuning required
- 48-pin TQFP package

Block Diagram

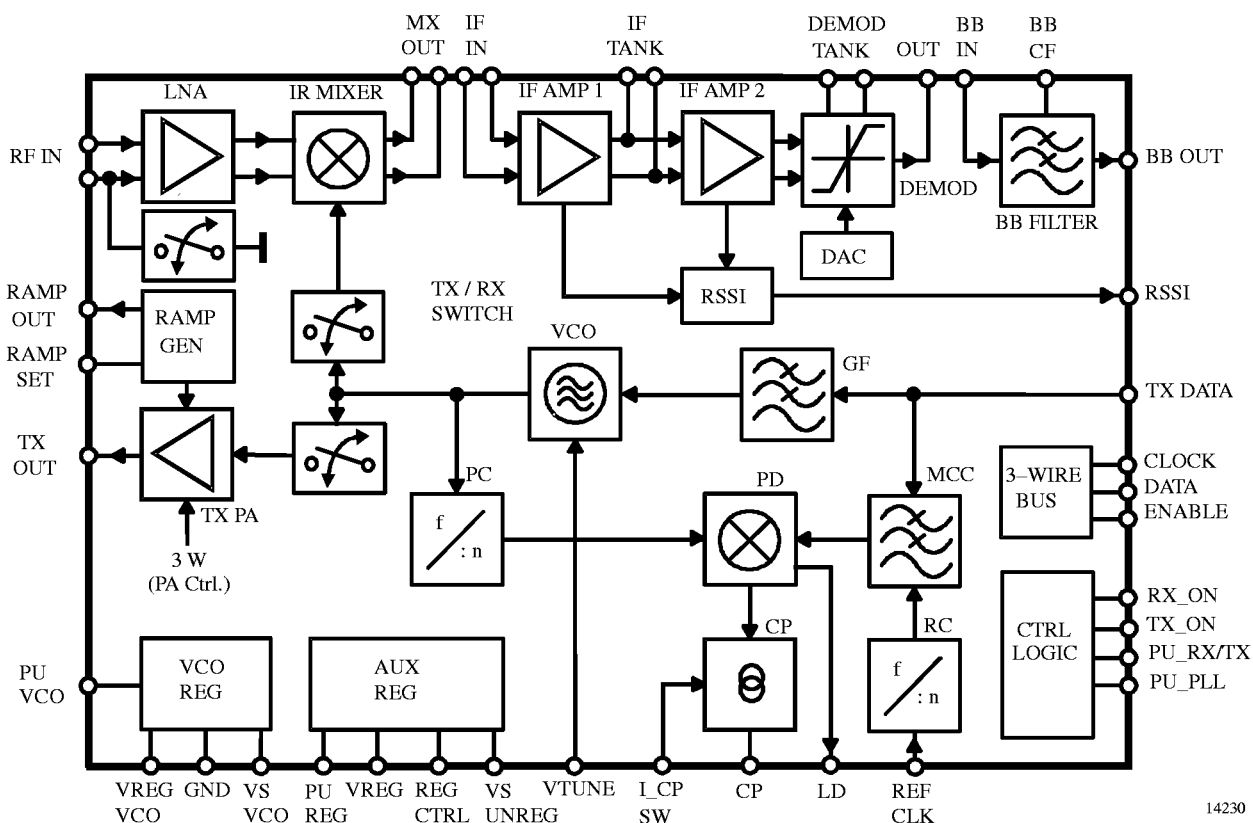


Figure 1. Block diagram

Ordering Information

Extended Type Number	Package	Remarks
T2901- MFY	TQFP48	
T2901- MFYR	TQFP48	Taped and reeled

Functional Blocks

Name	Description
AUX REG	Auxiliary voltage regulator
BBF	Baseband filter
CP	Charge pump
DAC	D/A converter for demodulator tuning
GF	Gaussian filter for transmit data
IF AMP1	1st intermediate frequency amplifier
IF AMP2	2nd intermediate frequency amplifier
IR MIXER	Image rejection mixer
LNA	Low noise amplifier

Name	Description
MCC	Modulation-compensation circuit
PC	Programmable counter
PD	Phase detector
RAMP GEN	Ramp-signal generator
RC	Reference counter
RSSI	Received signal-strength indicator
TX PA	Transmit power amplifier
VCO	Voltage-controlled oscillator
VCO REG	Voltage regulator for VCO

Pin Description

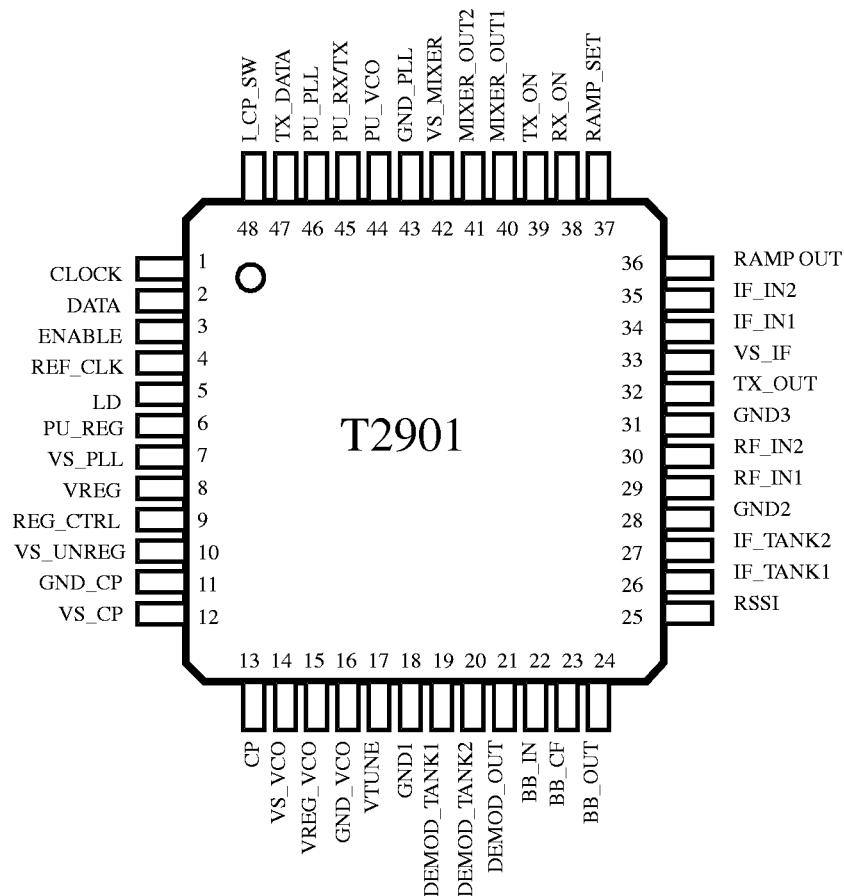


Figure 2. Pinning

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Pin Description (continued)

Pin	Symbol	Function
1	CLOCK	3-wire-bus: Clock input
2	DATA	3-wire-bus: Data input
3	ENABLE	3-wire-bus: Enable input
4	REF_CLK	Reference frequency input
5	LD	Lock-detect output
6	PU_REG	Auxiliary voltage regulator power-up input
7	VS_PLL	PLL supply voltage
8	VREG	Aux. voltage regulator output
9	REG_CTRL	Aux. voltage regulator control output
10	VS_UNREG	Aux. voltage regulator supply voltage
11	GND_CP	Charge pump ground
12	VS_CP	Charge pump supply voltage
13	CP	Charge pump output
14	VS_VCO	VCO voltage regulator supply voltage
15	VREG_VCO	VCO voltage regulator control output
16	GND_VCO	VCO ground
17	VTUNE	VCO tuning voltage input
18	GND1	Ground
19	DEMOD_TANK1	Demodulator tank circuit
20	DEMOD_TANK2	Demodulator tank circuit
21	DEMOD_OUT	Demodulator output
22	BB_IN	Baseband filter input
23	BB_CF	Baseband filter corner frequency control input
24	BB_OUT	Baseband filter output
25	RSSI	Received signal strength indicator output
26	IF_TANK1	IF tank circuit
27	IF_TANK2	IF tank circuit
28	GND2	Ground
29	RF_IN1	Differential RF input 1 to the image reject mixer
30	RF_IN2	Differential RF input 2 to the image reject mixer
31	GND3	Ground
32	TX_OUT	TX PA output
33	VS_IF	IF amplifier supply voltage
34	IF_IN1	Differential IF input of the IF amplifier
35	IF_IN2	Differential IF input of the IF amplifier
36	RAMP_OUT	Ramp generator output for ext. PA power ramping
37	RAMP_SET	Slew rate setting of ramping signal
38	RX_ON	RX section power up control input
39	TX_ON	TX section power up control input
40	MIXER_OUT1	Differential mixer output of the SAW
41	MIXER_OUT2	Differential mixer output of the SAW
42	VS_MIXER	Mixer supply voltage
43	GND_PLL	PLL ground
44	PU_VCO	VCO power-up input
45	PU_RX/TX	RX/TX power-up input
46	PU_PLL	PLL power-up input
47	TX_DATA	TX data input to Gaussian filter and modulation-compensation circuit
48	I_CP_SW	Charge pump current switch

Functional Description

Receiver

The RF-input signal at RF_IN is fed to an image-rejection mixer IR MIXER with its differential outputs MIXER_OUT1 and MIXER_OUT2 driving an IS-SAW filter at 110 MHz. The IF amplifiers IF_AMP1 and IF amplifier IF_AMP2 with an external IF_TANK and an integrated RSSI function fed the signal to the demodulator DEMOD and finally to an integrated baseband filter BB. For demodulator tuning in production, an integrated 5-bit Digital-to-Analog (D/A) converter is used to control the on-chip varicap diode.

Transmitter

The transmit data at TX_DATA is filtered by an integrated Gaussian filter GF and fed to the fully integrated VCO operating at twice the output frequency. After modulation, the signal is frequency-divided by 2 and fed via a TX/RX SWITCH to the TX DRIVER. This bus-controlled driver amplifier supplies +3 dBm output power at TX_OUT. A ramp-signal generator RAMP GEN, providing ramp signals at RAMP_OUT for an

external power amplifier, is also integrated. The slope of the ramp signal is controlled by a capacitor at RAMP_SET.

Synthesizer

The IR MIXER, the TX DRIVER and the programmable counter PC are driven by the fully integrated VCO (including on-chip inductors and varactors). An 3-bit Digital-to-Analog converter is used to preset the desired frequency. The output signal is frequency-divided to supply the desired frequency to the TX DRIVER, 0/ 90 degree phase shifter for the IR MIXER and to be used by the PC for the phase detector PD. Unlimited multi-slot operation is possible by using the integrated advanced closed-loop modulation concept based on the modulation compensation circuit MCC.

Power Supply

For minimum interference and maximum signal isolation, an integrated bandgap-stabilized voltage regulator for use with an external low-cost PNP transistor is implemented. Additionally three independent internal voltage regulators provide multiple power-down and current-saving modes.

Absolute Maximum Ratings

All voltages are referred to GND (Pins 11, 16, 18, 28, 31 and 43).

Parameter	Symbol	Min.	Typ.	Max.	Unit
Supply voltage Pins 7, 10, 12, 14, 33 and 42	V_{S_xxx}			6	V
Logic input voltage Pins 1, 2, 3, 6, 38, 39, 44, 45, 46, 48	V_{IN}	− 0.3		6	V
Junction temperature	T_{jmax}			125	°C
Storage temperature	T_{stg}	−40		125	°C

Thermal Resistance

Parameters	Symbol	Value	Unit
Junction ambient	R_{thJA}	130	K/W

Operating Range

All voltages are referred to GND (Pins 11, 16, 18, 28, 31 and 43).

Parameter	Symbol	Min.	Typ.	Max.	Unit
Regulated supply voltage Pins 7,12,14, 33 and 42	V_{S_xxx}	2.7	3.0	3.3	V
Unregulated supply voltage Pin 10	V_{S_unreg}	3.0		5.5	V
Ambient temperature	T_{amb}	−20	+25	+85	°C

Electrical Characteristics

Test conditions (unless otherwise specified) : $V_S = 3.0\text{ V}$, $T_{\text{amb}} = 25^\circ\text{C}$.

Parameters	Test Conditions / Pins	Symbol	Min.	Typ.	Max.	Unit
Power supply Pins 7, 10, 12, 14, 33 and 42						
Total supply current	TX	I_S		40		mA
	RX	I_S		40		mA
Standby current	PU = GND	I_S		1	100	μA
LNA + IR mixer Pins 29, 30, 40 and 41						
Image rejection ratio	Pins 40 and 41	IRR		20		dB
DSB noise figure	Pins 40 and 41	NFDSB= NFSSB		12		dB
Conversion gain	$R_{\text{load}} = 400\ \Omega$	G_{conv}		15		dB
Output interception point	Pins 40 and 41	OIP3		4		dBm
Input impedance	Pins 29 and 30	Z_{in}		50		Ω
Input matching	Pins 29 and 30	VSWR _{in}		<2:1		
TX PA Pin 32						
Max output power	Pwr setting = max	P _{max}	0	3	5	dBm
Min output power	Pwr setting = min	P _{min}		-27		dBm
RF leakage	In RX mode	P _{leak}		-30		dBm
Output impedance		Z_{out}		t.b.d.		Ω
Output interception point		OIP3		10		dBm
IF amplifier Pins 26, 27, 34 and 35						
Input impedance	Pins 34 and 35	Z_{in}	200		400	Ω
Lower cut-off frequency		f _{l3dB}		90		MHz
Upper cut-off frequency		f _{u3dB}		130		MHz
Power gain		G _p		85		dB
Bandwidth of external tank circuit	Pins 26 and 27	BW _{3dB}		10		MHz
Noise figure		NF		9		dB
RSSI Pins 25, 34 and 35						
RSSI sensitivity	at IF_IN1, IF_IN2 Pins 34 and 35	P _{min}		20		dB μV
RSSI compression	at IF_IN1, IF_IN2 Pins 34 and 35	P _{max}		100		dB μV
RSSI dynamic range		DR		80		dB
RSSI resolution	Slope of the RSSI has to be steady	Acc		± 3		dB
RSSI rise time	P _{in} < 30 to 100 dB μV , Pin 25	t _r		1		μs
RSSI fall time	P _{in} < 100 to < 30 dB μV , Pin 25	t _f		1		μs
Quiescent output voltage	P _{in} < 20 dB μV at IF_IN1, IF_IN2, Pin 25	V _{out}		0.45		V
Maximum output voltage	P _{in} = 100 dB μV at IF_IN1, IF_IN2, Pin 25	V _{out}		2.25		V

Electrical Characteristics (continued)

 Test conditions (unless otherwise specified) : $V_S = 3.0\text{ V}$, $T_{\text{amb}} = 25^\circ\text{C}$.

Parameters	Test Conditions / Pins		Symbol	Min.	Typ.	Max.	Unit
FM demodulator Pins 19, 20 and 21							
Co-channel rejection ratio	Pin = −75 dBm at IR-mixer input		CCRR		10		dB
Sensitivity	Quality factor of external tank circuit approx. 20, Pin 21		S		0.6		V/MHz
Amplitude of recovered signal	Nominal deviation of signal ± 160 kHz, Pin 21		A		200		mV _{pp}
Output voltage DC range	Pin 21		FMout _{DC}	0.4		V _s −0.4	V
Output impedance	Pin 21		Z _{out}		13		kΩ
AM rejection ratio	Pin 21		AMRR		t.b.d		dB
Baseband filter Pins 22, 23 and 24							
3 dB bandwidth	C _{ext} = 80 pF	Pin 24	PGBW		1.5		MHz
Output voltage range	Pin 24		V _{out}	1		V _s −1	V
Common-mode input voltage	Pin 22		V _{in}	1		V _s −1	V
Ramp generator Pin 36							
Rise time	Cramp = 270 pF at Pin 37		t _r		5		μs
Fall time	Cramp = 270 pF at Pin 37		t _f		5		μs
Minimum output voltage	Accord. PA ramp input		V _{min}		t.b.d.		V
Maximum output voltage	Accord. PA ramp input		V _{max}		t.b.d.		V
Logic input levels Pins 1, 2, 3, 38, 39, 47 and 48							
High input level	=‘1’		V _{iH}	1.5			V
Low input level	=‘0’		V _{iL}			0.5	V
High input current	=‘1’		I _{iH}	−5		5	μA
Low input current	=‘0’		I _{iL}	−5		5	μA
Power / standby Pins 6, 44, 45 and 46							
Power up PU = ‘1’			V _{PU}	2.0			V
High input level							
Standby PU = ‘0’			V _{PU,OFF}			0.7	V
Low input level							
Power up PU = ‘1’	V _{PU} = 3 V	Pin 6	I _{PU_REG}	20	30	40	μA
High input current		Pin 46	I _{PU_PL}	100	125	150	μA
	V _{PU} = 5.5 V	Pin 46	I _{PU_PL}	200	300	400	μA
		Pin 44	I _{PU_VCO}	60	80	100	μA
		Pin 45	I _{PU_RX/TX}	60	80	100	μA
Standby PU = ‘0’	V _{PU} = 0 V		I _{PU,OFF}			0.1	μA
Low input current	V _{PU} = 0.5 V					1	μA
Settling time VS = 0 → active operation	Switched VS = 0 to VS = 3 V		t _{soa}		< 10		μs
Settling time standby → active operation	Switched PU = 0 to PU = 1		t _{ssa}		< 10		μs
Settling time active operation→ standby	Switched VS = 3 V to VS = 0		t _{sas}		< 2		μs

Electrical Characteristics (continued)

Test conditions (unless otherwise specified) : $V_S = 3.0\text{ V}$, $T_{amb} = 25^\circ\text{C}$.

Parameters	Test Conditions / Pins	Symbol	Min.	Typ.	Max.	Unit
PLL						
Scaling factor prescaler		S_{PSC}		32/33		
Scaling factor main counter		S_{MC}	64		79	
Scaling factor swallow counter		S_{SC}	0		31	
External reference input frequency	AC-coupled sinewave @ 20 ppm accuracy, Pin 4	f_{REF_CLK}		13		MHz
External reference input voltage	AC-coupled sinewave, Pin 4	V_{REF_CLK}	50		250	mV _{RMS}
Total scaling factor reference counter	Pin 4	S_{RC}		13		
Charge pump active when RX, TX Pin 13						
Output current	$V_{L_CP_SW} = "0"$ $V_{CP} \leq V_{VS_CP} / 2$	I_{CP_1}		± 1		mA
	$V_{L_CP_SW} = "1"$ $V_{CP} \leq V_{VS_CP} / 2$	I_{CP_5}		± 5		mA
Current scaling factor	$I_{CP} = CPCS \times I_{CP_TYP}$ (see bus protocol D0 ... D1)	CPCS	80		110	%
Leakage current		I_L		± 100		pA
Modulation-compensation circuit @ maximum DSV ≤ 78						
Oversampling	$f_{REF_CLK} = 13\text{ MHz}$	OVS		1		
Integration counter		MAC	-63		+63	
Current scaling factor	(see bus protocol E3 ... E5)	MCCS	60		130	%
3-wire bus						
Clock	Pin 1	f_{clock}			6	MHz
Gaussian transmit filter, Gaussian shape B*T = 0.5						
Tx data filter clock	$f_{REF_CLK} = 13\text{ MHz}$, TX, 7 taps in filter	f_{TXFCLK}		6.5		MHz
GF adjustment range (for FM deviation adjustm.)	(see bus protocol D6 ... D8)	GFAR	60		130	%
Internal VCO						
Tuning range RX band	@ $f_{IF} = 110\text{ MHz}$	f_{VCO_RX}	2290		2390	MHz
Tuning range TX band		f_{VCO_TX}	2400		2500	MHz
Phase noise	@ 500 kHz offset Pin 21	N_{VCO}	-95			dBc/Hz
Phase noise, wideband	> 2 MHz offset Pin 21	N_{VCO}	-120			dBc/Hz
Tuning input sensitivity	Pin 17	S_{VCO_mod}		50		MHz/V

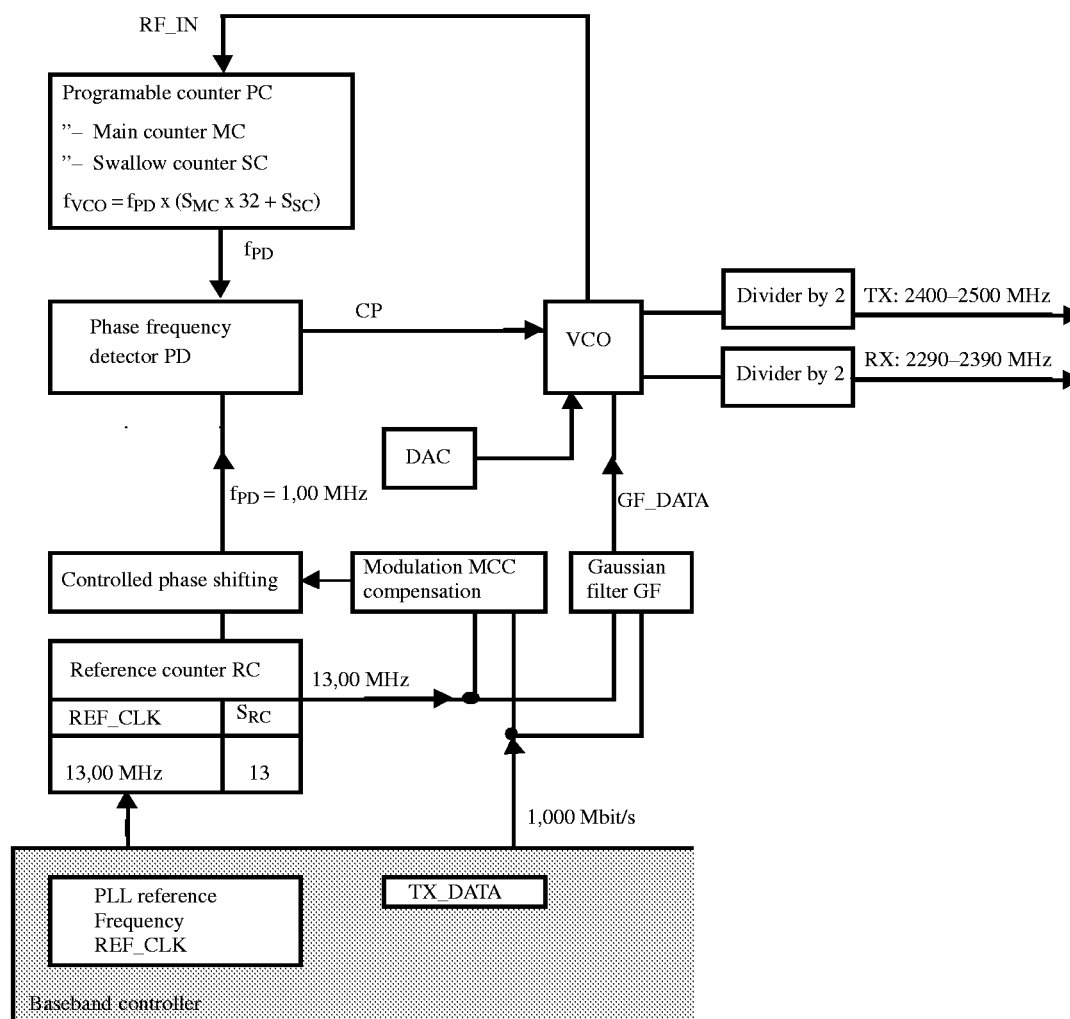
Electrical Characteristics (continued)

Parameters	Test Conditions / Pins	Symbol	Min.	Typ.	Max.	Unit
Internal VCO PRETUNE 4-bit programming (see bus protocol D2 ... D5)						
Stepwidth		f_{pretune}		30		MHz
Lock-detect output Pin 5						
Lock-detect output, test-mode output	locked = '1' unlocked = '0' (test modes see bus proto- col E0 ... E2)	LD				
Leakage current	$V_{\text{OH}} = 3.3 \text{ V}$ Pin 5	I_{L}			5	μA
Saturation voltage	$I_{\text{OL}} = 0.5 \text{ mA}$ Pin 5	V_{SL}			0.4	V

Table of Switch Settings in Different Modes

Mode	Standby	Synthesizer	RX Mode	TX Mode	RSSI
PU_PLL, PU_REG	0	1	1	1	1
PU_RX/TX	0	0	1	1	1
RX_ON	0	0	1	0	1
TX_ON	0	X	0	1	1
PU_VCO	0	1	1	1	1
VCO, PLL, prescaler, RX/TX switch	Off	On	On	On	On
PA, Ramp Gen, MCC, Gaussian filter	Off	Off	Off	On	Off
LNA, IR mixer, IF amplifier	Off	Off	On	Off	On
Demodulator, BB-filter	Off	Off	On	Off	Off

PLL Principle



14233

Figure 3.

Table 5. The following table shows the maximum programmable LO frequencies for RX and TX.

	f_{IF} [MHz]	f_{RX} [MHz]	f_{TX} [MHz]	S_{MC}	S_{SC}
min	111.0	2159.0	2048.0	64	0
max	111.0	2770.0	2559.0	79	31

Preset of MCC and Gaussian Transmit Filter for TX

After programming the PLL (3-wire bus Enable input going to high level) until start of the Data preamble, it is necessary to send a symmetrical alternating 1/0-datas-tream.

Serial Programming Bus

Reference and programmable counters can be programmed by the 3-wire bus (CLOCK, DATA and ENABLE). In addition to this information, further control bits such as the scaling of charge pump currents as well as internal currents for the Gaussian lowpass filter and modulation-compensation circuit can be transferred.

After setting the Enable signal to low condition, the data status is transferred bit by bit on the rising edge of the clock signal into the shift register, starting with the MSB-bit. When the Enable signal has returned to high condition, the programmed information is loaded into the addressed latches according to the address-bit condition

Bus Protocol Formats

MSB																							LSB	
Data bits																							Address bit	
D22	D21	D20	D19	D18	D17	D16	D15	D14	D13	D12	D11	D10	D9	D8	D7	D6	D5	D4	D3	D2	D1	D0	A0	
MC				SC					PS		PA		GF	MCC	GFCS			VCO-DAC				CPCS		1
1	1	0	0	1	0	0	1	1	1	1	0	1	1	0	1	1	1	0	0	0	1	0	1	

Standard bit setting:

Word 1

Word 2

Data bits											Address bit
E10	E9	E8	E7	E6	E5	E4	E3	E2	E1	E0	A0
DEMODOAC					MCCS			TEST			0
1	0	0	0	0	1	0	0	0	0	0	0

PLL Settings

MC (Main Counter)							
			D22	D21	D20	D19	S _{MS}
1	0	0	0	0	0	0	64
1	0	0	0	0	0	1	65
1	0	0	...	...	...	...	...
1	0	0	1	1	1	0	78
1	0	0	1	1	1	1	79

SC (Swallow Counter)					
D18	D17	D16	D15	D14	S _{SC} [*])
0	0	0	0	0	0
0	0	0	0	1	1
0	0	0	1	0	2
...	...	...	...	...	... ^{**})
1	1	0	1	1	30
1	1	1	1	0	31

* $S_{SC} = [D14] \times 2^0 + [D15] \times 2^1 + \dots [D218] \times 2^4$

** $S_{PGD} = 32 \times S_{MC} + S_{SC}$

Gauss Filter and Modulation Compensation Settings

D10	GF (Gaussian Filter)
0	OFF
1	ON
D9	MCC (Modulation Compensation Circuit)
0	OFF
1	ON
D13	PS (Phase Select Modulation-Compensation Circuit)
0	inverted
1	normal

GFCS (Gaussian Filtered Current Settings)			
D8	D7	D6	GFCS
0	0	0	60%
0	0	1	70%
0	1	0	80%
0	1	1	90%
1	0	0	100%
1	0	1	110%
1	1	0	120%
1	1	1	130%

MCCS (Modulation Compensation Current Settings)			
E5	E4	E3	MCCS
0	0	0	60%
0	0	1	70%
0	1	0	80%
0	1	1	90%
1	0	0	100%
1	0	1	110%
1	1	0	120%
1	1	1	130%

Power Amplifier and Charge Pump Settings

PA (Output Power Settings)		
D12	D11	PA
0	0	-17 dBm
0	1	-7 dBm
1	0	-1 dBm
1	1	+3 dBm

CPCS (Charge-Pump Current Settings)		
D1	D0	CPCS
1	0	80%
1	1	90%
0	0	100%
0	1	110%

Pretune DAC Voltage Settings

$$V_{TUNE} = V_{CC}/2$$

Pretune DAC Voltage (Internal Connection)				
D5	D4	D3	D2	$f_{VCC}/\%$
0	0	0	0	-6.0
0	0	0	1	...
0	1	0	0	...
0	1	1	1	...
1	0	0	0	...
1	0	1	1	...
1	1	0	0	...
1	1	1	1	6.0

DEMODO DAC Voltage Settings (DEMODO DAC)

Demod DAC Voltage (Internal Connection)					
E10	E9	E8	E7	E6	$f_{ifcenter}/\%$
0	0	0	0	0	-6.0
0	0	0	0	1	...
0	0	0	1	0	...
					...
1	1	1	0	1	...
1	1	1	1	0	...
1	1	1	1	1	6.0

Test Mode Settings

Test Output Pin (Lock Detect)			
E2	E1	E0	Signal at lock detect and PLL mode
0	0	0	Lock detect mode
0	0	1	PC out divided by two and CP active (phase changed)
0	1	0	RC out divided by two and CP active (phase changed)
0	1	1	MCCTEST (REF_CLK divided by 1664)
1	0	0	CP tristate only
1	0	1	RC out divided by two and CP high impedance
1	1	0	PC out divided by two and CP high impedance
1	1	1	GFTEST (REF_CLK divided by 4)

3-Wire Bus Protocol Pulse Diagram

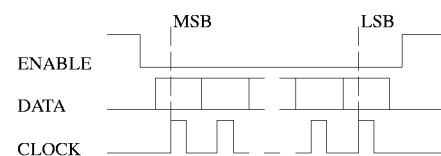


Figure 4.

3-Wire Bus Protocol Timing Diagram

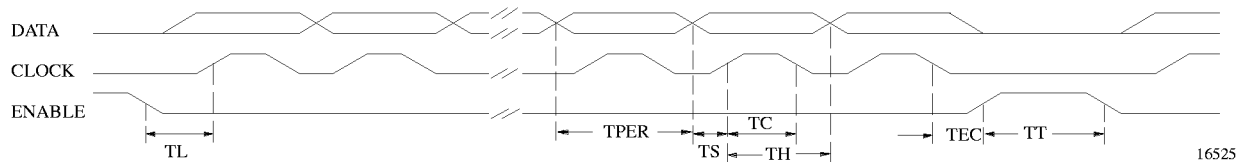
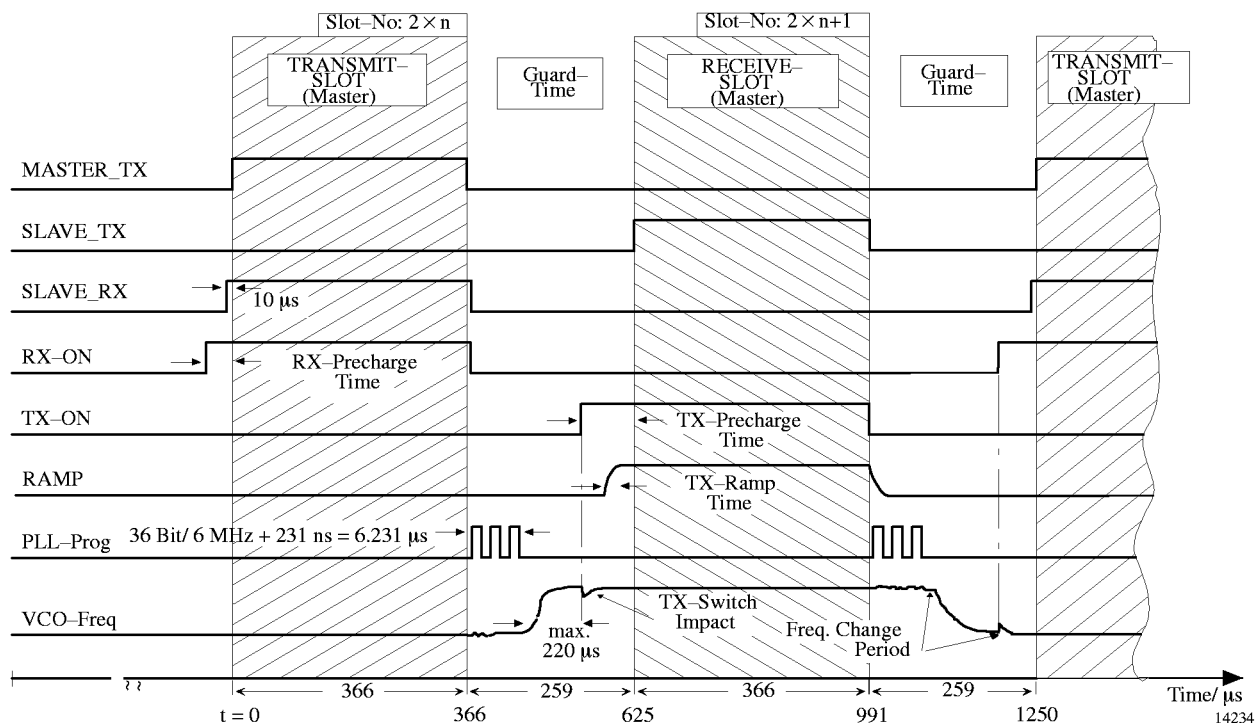


Figure 5.

Table 6. Bus signal times

Description	Symbol	Min. Value	Unit
Clock period	TPER	1/ (6.5 MHz)	μs
Set time data to clock	TS	60	ns
Hold time data to clock	TH	60	ns
Clock pulse width	TC	1/ (13 MHz)	μs
Set time enable to clock	TL	3/ (13 MHz)	μs
Hold time enable to clock	TEC	0	ns
Time between two protocols	TT	3/ (13 MHz)	μs

Bluetooth RX/TX Timing Diagram



Typical Application Circuit

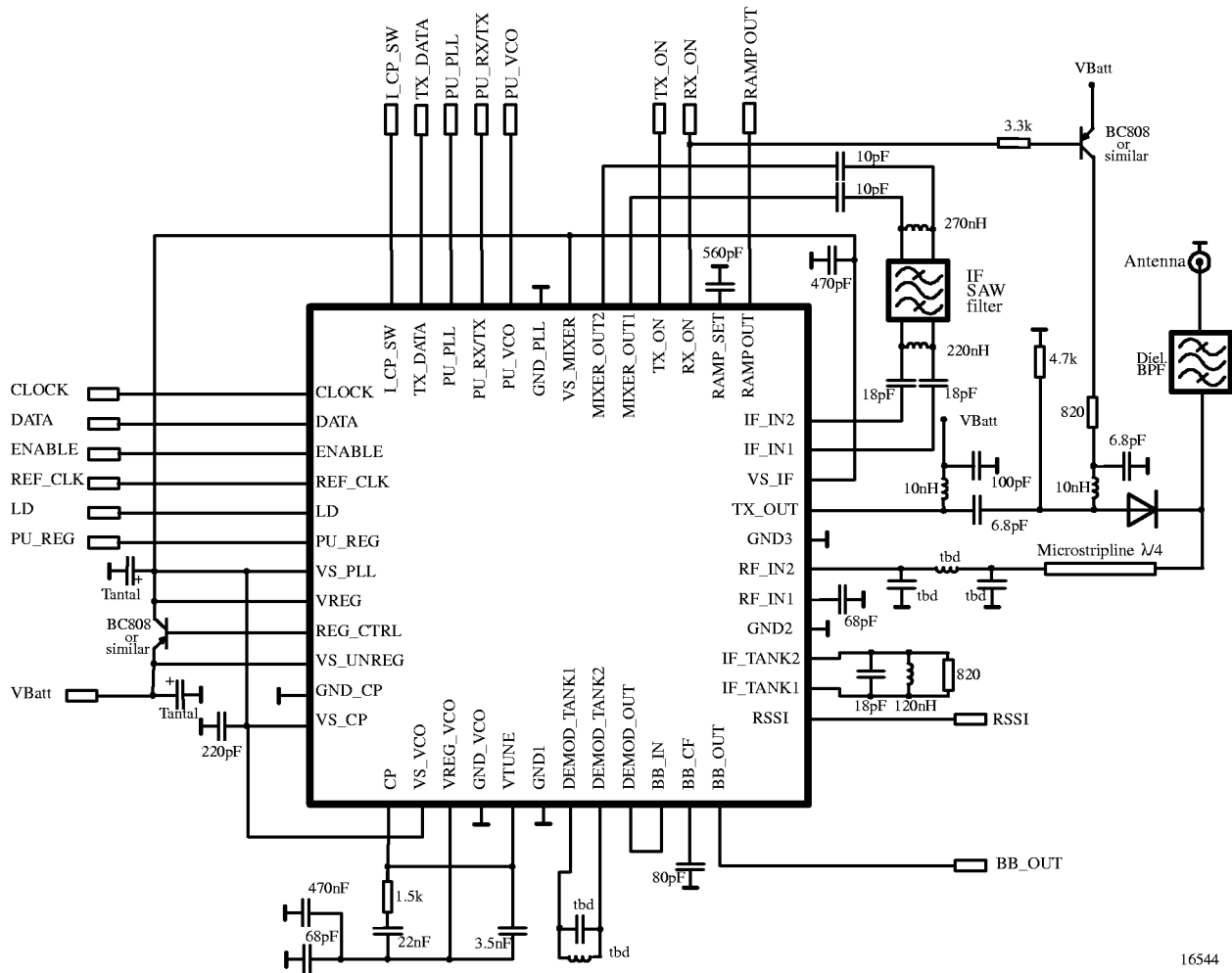


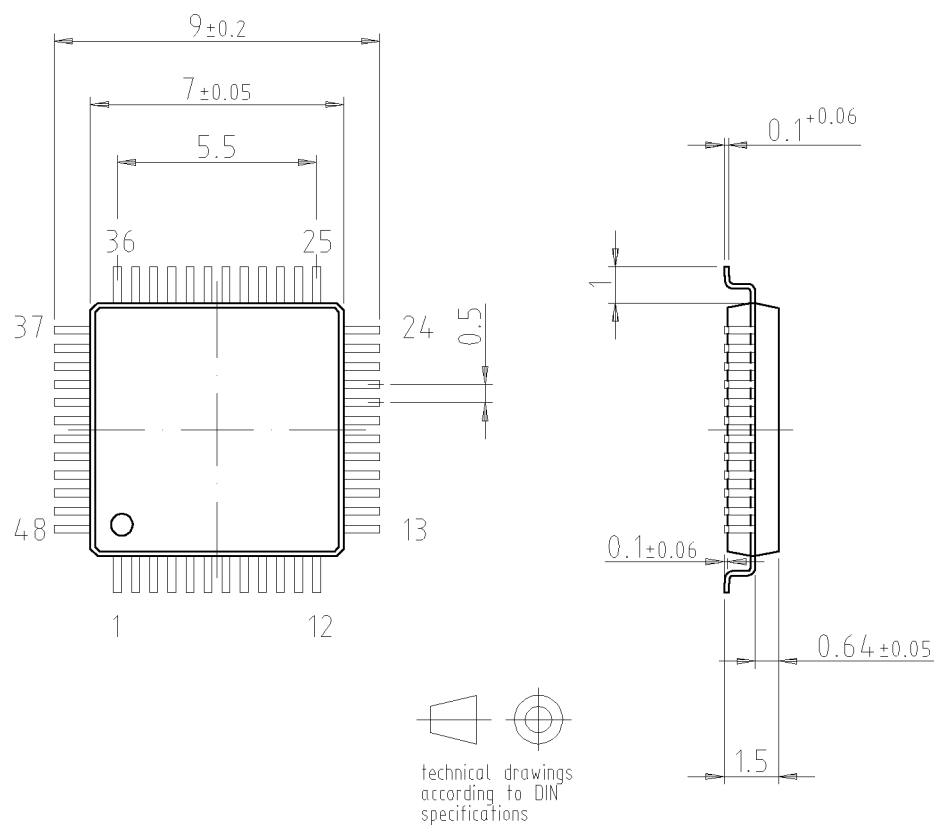
Figure 6. Application circuit

16544

Package Information

Package TQFP48

Dimensions in mm



13053